Appl. No. 10/509,850 Amdt. dated February 28, 2007 Reply to Office Action of August 29, 2006

## **Amendments to the Specification:**

Please replace paragraph [0001] of the substitute specification with the following amended paragraph:

[0001] The invention relates to a plasma spraying method. The generic process, described in US patent 5,853,815, which is incorporated by reference herein, is a thermal spraying for the manufacture of a so-called LPPS (= low pressure plasma spraying) thin film. The invention also relates to applications of the method and to components which are coated in accordance with the method in accordance with the invention.